C1608JB1E155M080AB



TDK item description C1608JB1E155MT****

Applications	Commercial Grade
Feature	General General (Up to 50V)
Series	C1608 [EIA 0603]
Status	Production



	Size
Length(L)	1.60mm ±0.10mm
Width(W)	0.80mm ±0.10mm
Thickness(T)	0.80mm ±0.10mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	0.30mm Min.
Decommonded Land Dattern (DA)	0.70mm to 1.00mm(Flow Soldering)
Recommended Land Pattern (PA)	0.60mm to 0.80mm(Reflow Soldering)
Recommended Land Pattern (PB)	0.80mm to 1.00mm(Flow Soldering)
	0.60mm to 0.80mm(Reflow Soldering)
Recommended Land Pattern (PC)	0.60mm to 0.80mm(Flow Soldering)
	0.60mm to 0.80mm(Reflow Soldering)

Electrical Characteristics		
Capacitance	1.5μF ±20%	
Rated Voltage	25VDC	
Temperature Characteristic	JB(±10%)	
Dissipation Factor (Max.)	10%	
Insulation Resistance (Min.)	333ΜΩ	

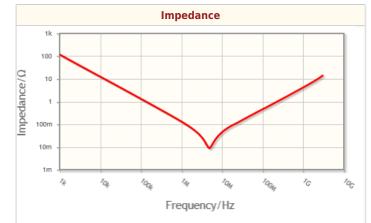
	Other	
Coldering Method	Wave (Flow)	
Soldering Method	Reflow	
AEC-Q200	No	
Packing	Punched (Paper)Taping [180mm Reel]	
Package Quantity	4000pcs	

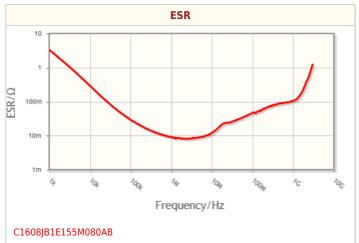
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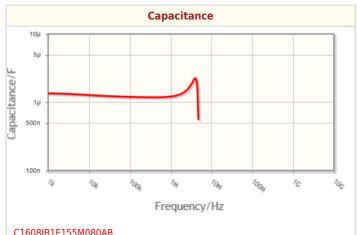
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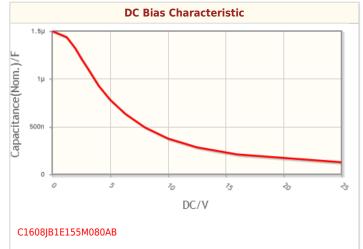




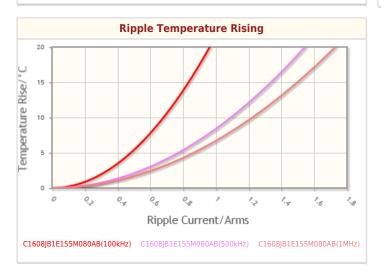


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Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

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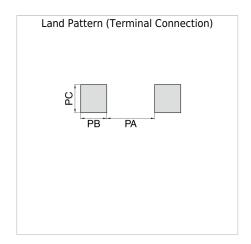
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Associated Images



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